DECLARATION AND P IR OF ATTORNEY FOR PATEN

PPLICATION

DOCKET NO. **TSMC2000-234**

As a below named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Elastomer Plating Mask Sealed Wafer Level Package Method

the specification of which (check one)			
X is attached hereto.			
was filed on			
Application Serial No.			
and was amended on(if a	1:1:-		
I hereby state that I have reviewed and tamended by any amendment referred to	understand the contents of the al	bove Identified specification including the	claims, as
I acknowledge the duty to disclose infor 37, Code of Federal Regulations, §1.56(mation which is material to the (a).	examination of this application in accordan	nce with Title
a filing date before that of the application	nder Title 35, United States Couve also identified below any for n on which priority is claimed:	de §119 of any foreign application(s) for peign application for patent or inventor's ce	oatent or ertificate having
Prior Foreign Application(s)		Priority Claime	đ:
(Number)	(Country)	(Day/Month/Year Filed)	
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(Number)	(Country)	(Day/Month/Year Filed)	
		osed in the prior United States application acknowledge the duty to disclose material ed between the filing date of the prior app	l information a lication and the
(Application Serial No.)	(Filing Date) (Status)	(patented, pending, abandoned)	
I hereby declare that all statements made belief are believed to be true; and further the like so made are punishable by fine of that such willful false statements may jee	herein of my own knowledge a r that these statements were mader imprisonment, or both, under opardize the validity of the appli	are true and that all statements made on inde with the knowledge that willful false states Section 1001 of Title 18 of the United States or any patent issued thereon.	formation and stements and ates Code and
POWER OF ATTORNEY: As a named application and transact all business in the	inventor, I hereby appoint the fine Patent and Trademark Office	ollowing attorney(s) and/or agent(s) to proconnected therewith. (list name & registra	osecute this ation no.)
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